Chapter 7

Hardware Implementation Tools
The testing and embedding speech processing algorithm on general purpose PC and dedicated DSP platform require specific hardware implementation tools. Real time digital signal processing made considerable advancements after the introduction of specialized DSP processors. Suitable starter kits with a specific DSP processor and related software tools such as compilers, assemblers, simulators, debuggers, and so on, are provided in order to make system design and application development easier. The 32-bit floating point processor TMS320C6713 from Texas Instruments is very powerful for real time speech and audio processing algorithm implementations. This DSP processor is based on the VLIW (Very Large Instruction Word) technology, which allows fast parallel computing jointly using its optimized "C" compiler. For a rapid evaluation of the TMS320C6713 processor a Developer Starter Kit 6713 (DSK 6713) is available from Spectrum Digital Incorporation; comprises a board and the software tools. The board must be connected to a standard PC running under its integrated development environment- Code Composer Studio (CCS IDE). For rapid prototyping, testing and debugging of developed algorithm the Real Time Workshop (RTW) toolbox and MATLAB link for embedded target called Target Support Package TC6 is used.

7.1 The Digital Signal Processor: TMS320C6713

The TMS320C6000 platform of digital signal processors (DSPs) is part of the TMS320 family of DSPs. The TMS320C67x ("C67x) devices are floating-point DSPs in the TMS320C6000 platform. The TMS320C67x DSPs (including the TMS320C6713 device) compose the floating-point DSP generation in the TMS320C6000 DSP platform [1]. The C6713 device is based on the high-performance, advanced very-long-instruction-word (VLIW) architecture developed by Texas Instruments (TI), making this DSP an excellent choice for multichannel and multifunction applications. Operating at 225 MHz, the C6713 delivers up to 1350 million floating-point operations per second (MFLOPS), 1800 million instructions per second (MIPS), and with dual fixed-/floating-point multipliers up to 450 million multiply-accumulate operations per second (MMACS). Operating at 300 MHz, the C6713 delivers up to 1800 million floating-point operations per second (MFLOPS), 2400 million instructions per second (MIPS), and with dual fixed-/floating-point multipliers up to 600 million multiply-accumulate operations per second (MMACS).

The C6713 uses a two-level cache-based architecture and has a powerful and diverse set of peripherals. The Level 1 program cache (L1P) is a 4K-byte direct-mapped cache and the
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Level 1 data cache (L1D) is a 4K-byte 2-way set-associative cache. The Level 2 memory/cache (L2) consists of a 256K-byte memory space that is shared between program and data space. 64K bytes of the 256K bytes in L2 memory can be configured as mapped memory, cache, or combinations of the two. The remaining 192K bytes in L2 serve as mapped SRAM.

The C6713 has a rich peripheral set that includes two Multichannel Audio Serial Ports (McASPs), two Multichannel Buffered Serial Ports (McBSPs), two Inter-Integrated Circuit (I²C) buses, one dedicated General-Purpose Input/Output (GPIO) module, two general-purpose timers, a host-port interface (HPI), and a glue less external memory interface (EMIF) capable of interfacing to SDRAM, SBSRAM, and asynchronous peripherals. The two McASP interface modules each support one transmit and one receive clock zone. Each of the McASP has eight serial data pins, which can be individually allocated, to any of the two zones. The serial port supports time-division multiplexing on each pin from 2 to 32 time slots. The C6713B has sufficient bandwidth to support all 16 serial data pins transmitting a 192 kHz stereo signal. Serial data in each zone may be transmitted and received on multiple serial data pins simultaneously and formatted in a multitude of variations on the Philips Inter-IC Sound (I²S) format. In addition, the McASP transmitter may be programmed to output multiple S/PDIF, IEC60958, AES-3, CP-430 encoded data channels simultaneously, with a single RAM containing the full implementation of user data and channel status fields. The McASP also provides extensive error checking and recovery features, such as the bad clock detection circuit for each high-frequency master clock, which verifies that the master clock is within a programmed frequency range. The two I²C ports on the TMS320C6713 allow the DSP to easily control peripheral devices and communicate with a host processor. In addition, the standard multichannel-buffered serial port (McBSP) may be used to communicate with serial peripheral interface (SPI) mode peripheral devices.

The TMS320C6713 device has two boot modes: from the HPI or from external asynchronous ROM. The TMS320C67x DSP generation is supported by the TI eXpressDSP - set of industry benchmark development tools, including a highly optimizing C/C++ Compiler, the Code Composer Studio - Integrated Development Environment (IDE), JTAG-based emulation and real-time debugging, and the DSP/BIOS kernel.

7.1.1 DSP 6713 Features

- Highest-Performance Floating-Point Digital Signal Processor (DSP):
• Advanced Very Long Instruction Word (VLIW) TMS320C67x DSP Core
  ➢ Eight Independent Functional Units:
    o 2 ALUs (Fixed-Point)
    o 4 ALUs (Floating-/Fixed-Point)
    o 2 Multipliers (Floating-/Fixed-Point)
  ➢ Load-Store Architecture with 32 32-Bit General-Purpose Registers
  ➢ Instruction Packing Reduces Code Size
  ➢ All Instructions Conditional

• Instruction Set Features
  ➢ Native Instructions for IEEE 754: Single and Double precision
  ➢ Byte-Addressable (8-, 16-, 32-Bit Data)
  ➢ 8-Bit Overflow Protection
  ➢ Saturation; Bit-Field Extract, Set, Clear; Bit-Counting; Normalization

• L1/L2 Memory Architecture
  ➢ 4K-Byte L1P Program Cache (Direct-Mapped)
  ➢ 4K-Byte L1D Data Cache (2-Way)
  ➢ 256K-Byte L2 Memory Total: 64K-Byte L2 Unified Cache/Mapped RAM, and 192K-Byte Additional L2 Mapped RAM

• Device Configuration
  ➢ Boot Mode: HPI, 8-, 16-, 32-Bit ROM Boot
  ➢ Endianness: Little Endian, Big Endian

• 32-Bit External Memory Interface (EMIF)
  ➢ Glue less Interface to SRAM, EPROM, Flash, SBSRAM, and SDRAM
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- 512M-Byte Total Addressable External Memory Space
- Enhanced Direct-Memory-Access (EDMA) Controller (16 Independent Channels)
- 16-Bit Host-Port Interface (HPI)
- Two McASPs
  - Two Independent Clock Zones Each (1 TX and 1 RX)
  - Eight Serial Data Pins per Port: Individually Assignable to any of the Clock Zones
  - Each Clock Zone Includes:
    - Programmable Clock Generator
    - Programmable Frame Sync Generator
    - TDM Streams From 2-32 Time Slots
    - Support for Slot Size: 8, 12, 16, 20, 24, 28, 32 Bits
    - Data Formatter for Bit Manipulation
  - Wide Variety of I2S and Similar Bit Stream Formats
  - Integrated Digital Audio Interface Transmitter (DIT) Supports:
    - S/PDIF, IEC60958-1, AES-3, CP-430 Formats
    - Up to 16 transmit pins
    - Enhanced Channel Status/User Data
  - Extensive Error Checking and Recovery
  - Two Inter-Integrated Circuit Bus (I²C Bus) Multi-Master and Slave Interfaces
- Two Multichannel Buffered Serial Ports:
  - Serial-Peripheral-Interface (SPI)
  - High-Speed TDM Interface
  - AC97 Interface
- Two 32-Bit General-Purpose Timers
- Dedicated GPIO Module with 16 pins (External Interrupt Capable)
- Flexible Phase-Locked-Loop (PLL) Based Clock Generator Module
- IEEE-1149.1 (JTAG) Boundary-Scan-Compatibl e
- 208-Pin Power PAD PQFP (PYP)
- 272-BGA Packages (GDP and ZDP)
- 0.13-µm/6-Level Copper Metal Process
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- CMOS Technology
  - 3.3-V I/Os, 1.2-V Internal (GDP/ZDP/ PYP)
  - 3.3-V I/Os, 1.4-V Internal (GDP/ZDP) [300 MHz]

The functional block diagram and CPU core diagram is shown in figure 7.1.

![Functional block diagram and CPU core diagram of C6713](image)

Fig. 7.1 Functional block and CPU (DSP core) diagram of C6713

7.2 DSK 6713

The DSK6713 is a low cost standalone development platform that enables users to evaluate and develop applications for the TI 67XX DSP family. The block diagram describing the board is shown in figure 7.2. Key features include:
- A TI TMS320C6713 DSP operating at 225 MHz.
- An AIC 23 stereo codec.
- 4 user LEDs and 4 DIP switches.
- 16 MB SDRAM and 512 KB non-volatile Flash memory.
- Software board configuration through registers implemented in CPLD.
- JTAG (Joint Test Action Group) emulation through on-board JTAG emulator with USB host interface or external emulator.
- Single voltage power supply (+5V).

![DSK 6713 block diagram](image)

**Fig. 7.2 DSK 6713 block diagram**

### 7.2.1 Functional Overview of DSK 6713

The DSP on the 6713 DSK interfaces to on-board peripherals through a 32-bit wide EMIF (External Memory Interface). The SDRAM, Flash and CPLD are all connected to the bus. All addresses are 32 bits wide. Portions of the internal memory can be reconfigured in software as L2 cache rather than fixed RAM. The DSP interfaces to analog audio signals through on-board TLV320AIC23 codec and 3.5mm audio jacks (microphone input, line input, line output and headphone output). The codec can select the microphone input (monaural input) or the line input (stereo input) as active input. The analog output is driven to both the line out (fixed gain) and headphone/speaker out (adjustable gain) connectors. The codec communicates using two
serial channels, one to control the codec’s internal configuration registers and one to send and receive digital audio samples. McBSP0 is used to send commands to the codec control interface while McBSP1 is used for bi-directional digital audio data. The codec has a 12 MHz system clock. The internal sample rate generate subdivides the 12 MHz clock to generate common frequencies such as 48 KHz, 44.1 KHz and 8 KHz. The sample rate is set by the codec’s SAMPLERATE register. Figure 7.3 shows the codec interface on the C6713 DSK.

A programmable logic device called a CPLD is used to implement glue logic that ties the board components together. The CPLD has a register based user interface that lets the user configure the board by reading and writing to its registers. The DSK includes 4 LEDs (D7-D10) and 4 DIP switches (SW1) as a simple way to provide the user input/output. Both are accessed by reading and writing to the CPLD registers.

The PC’s USB port cannot be directly connected to DSP C6713. An XDS (eXtended Development System) JTAG emulator is connected to the PC’s USB port and DSP is communicated through the JTAG emulator on the DSK. CCS uses USB port to control DSP via JTAG port.

![Codec Interface Diagram](image)

Fig. 7.3 AIC- DSP interface

### 7.3 Code Composer Studio Integrated Development Environment (CCS IDE)

The Code Composer Studio (CCS) application provides an integrated environment with the following capabilities [2]:

- Integrated development environment (IDE) with an editor, debugger, project
manager, profiler, etc.

- ‘C/C++’ compiler, assembly optimizer and linker (code generation tools).
- Simulator.
- Real-time operating system (DSP/BIOS).
- Real-Time Data Exchange (RTDX) between the Host and Target.
- Real-time analysis and data visualization.

The CCS Project Manager organizes files into folders for source files; include files, libraries and DSP/BIOS configuration files. Once the files are added to the project any changes in any of source files will be reflected automatically in the project files. This allows multi user system development. CCS also provides the ability to debug mixed, multi-processor designs simultaneously. It also includes new emulation capabilities with Real Time Data Exchange (RTDX), plus advanced DSP code profiling capabilities. An improved Watch Window monitors the values of local and global variables and C/C++ expressions. Users can quickly view and track variables on the target hardware. It has ability to share C and C++ source and libraries in a multi-user project. The CCS IDE V3.3 is used for implementation here.

![Diagram of Code Composer Studio](image)

**Fig. 7.4 Working of code composer studio**
7.4 MATLAB/SIMULINK in Real Time Applications

Rapid prototyping is a new approach in digital signal processing systems development. With the advent of MATLAB's Real Time Workshop (RTW) toolbox it is now possible to compile, load, and execute graphically designed SIMULINK models on an actual DSP platform, without spending many workdays coding in typical DSP-oriented languages (assembly languages), or C/C++ compilers. RTW supports the powerful Texas Instruments 'C6000 series, including the TMS320C6713 DSP. The basic steps of the complete project development include designing an algorithm for the given task, implementing a suitable algorithm in MATLAB and SIMULINK and finally, translating it into target DSP code by means of a rapid prototyping approach. The original code was developed in MATLAB and so the MATLAB's Real Time Workshop (RTW) platform is used for rapid prototyping. Real-Time Workshop builds applications from SIMULINK diagrams for prototyping, testing, and deploying real-time systems on a variety of target computing platforms, including Texas Instruments C6000 class DSP processors (Target Support Package TC6).

7.4.1 Real Time Workshop Toolbox

Real Time Workshop is an extension of capabilities of SIMULINK and MATLAB that automatically generates packages and compiles source code from SIMULINK models to create real-time software applications on a variety of systems [3]. By providing a code generation environment for rapid prototyping and deployment, Real-Time Workshop is the foundation for production code generation capabilities. Along with other tools and components from MATLAB, Real-Time Workshop provides automatic code generation tailored for a variety of target platforms, a rapid and direct path from system design to implementation, seamless integration with MATLAB and SIMULINK, a simple graphical user interface, an open architecture and extensible make process. The principal components and features of Real-Time Workshop [4] are:

- SIMULINK Code Generator: - Automatically generates C code from the SIMULINK model.
- Make Process: - The Real-Time Workshop user-extensible make process lets us customize compilation and linking of generated code for our own production or rapid prototyping target.
- SIMULINK External Mode: - External mode enables communication between SIMULINK and a model executing on a real-time test environment, or in another process on the same machine. External mode lets us to perform real-time parameter tuning, data logging, and viewing using SIMULINK as a front end.

- Targeting Support: - Using the targets bundled with Real-Time Workshop, we can build systems for real-time and prototyping environments. The generic real-time and other bundled targets provide a framework for developing customized rapid prototyping or production target environments.

- Rapid Simulations: - Using SIMULINK Accelerator, the S-Function Target, or the Rapid Simulation Target, we can accelerate our simulations by 5 to 20 times on average. Executables built with these targets bypass normal SIMULINK interpretive simulation mode. Code generated by SIMULINK Accelerator, S-Function Target, and Rapid Simulation Target is highly optimized to execute only the algorithms used in our specific model. In addition, the code generator applies many optimizations, such as eliminating ones and zeros in computations for filter blocks.

- Large-Scale Modeling: - Support for multilevel modeling (termed "model referencing"), which lets us to generate code incrementally for a hierarchy of independent component models, as they evolve.

The Target Language Compiler (TLC) tool is an integral part of the Real-Time Workshop. It enables customizing the C code generated from any SIMULINK model and generates optimal, inline code for SIMULINK blocks. Figure 7.5 illustrates how Real-Time Workshop, helps us in real time system development process and figure 7.6 explains its working.
Fig. 7.5 Role of real time workshop
7.4.2 Target Support Package TC6

This platform integrates SIMULINK and MATLAB with Texas Instruments eXpressDSP tools. The software collection allows developing and validating digital signal processing designs from concept through code. It consists of the TI C6000 target that automates rapid prototyping on C6000 hardware targets [5]. The target uses C code generated by RTW and CCS to build an executable file (.out) for the targeted processor. The RTW build process loads the targeted machine code to target board and runs the executable file on the digital signal processor. All the features provided by CCS, such as tools for editing, building, debugging, code profiling, and project management help in developing the applications using MATLAB, SIMULINK, RTW, and the supported hardware (DSK 6713). Executing code generated from RTW on a particular target in real time requires that RTW generate target code that is tailored to the specific hardware target. Target-specific code includes I/O device drivers and an interrupt service routine (ISR). Since these device drivers and ISRs are specific to particular hardware targets, it must be ensured that the target-specific components are compatible with the target hardware. To build an executable, TC6 uses the MATLAB links to invoke the code building process from within CCS. Once executable file is downloaded to the target and run, the code runs wholly on the target; one
can access the running process only from the CCS debugging tools or across a link for CCS [6] or Real Time Data Exchange (RTDX). Otherwise the running process is not accessible.

7.5 Summary

The hardware implementation tools viz. DSK 6713, CCS IDE, SIMULINK, MATLAB RTW and Target Support Package TC6 together can be used to implement any complex speech processing algorithm on TMS320C6713 DSP platform. The ADC and DAC needed for such applications are provided on DSK 6713. Also SIMULINK can be used for real time implementation of speech processing algorithm on PC\(^1\). The sound card on PC contains necessary ADC, DAC and audio power amplifiers. The hybrid algorithm developed here is tested for real time implementation on PC as well as on DSP. The implementation details are described in the next chapter.